



PATENT Attorney Docket No. ASC-025DV1C1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S):

Cheng et al.

SERIAL NO.:

10/802,185

GROUP NO.:

2813

FILING DATE:

March 17, 2004

EXAMINER:

Craig Thompson

TITLE:

SEMICONDUCTOR SUBSTRATE STRUCTURE

CERTIFICATE OF FIRST CLASS MAILING UNDER 37 C.F.R. 1.8

I hereby certify that this correspondence, and any document(s) referred to as enclosed herein, is/are being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 3¹¹⁴ day of April, 2005.

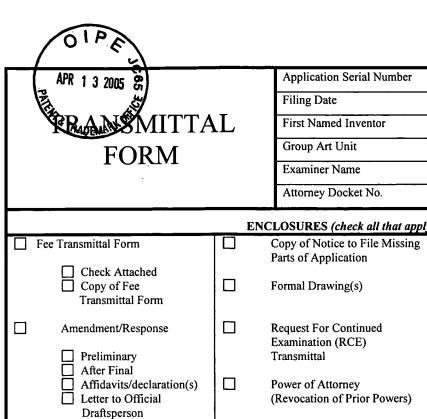
Wendy L. Marfin

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Submitted herewith are:

- 1. Transmittal Form (1 page);
- 2. Supplemental Information Disclosure Statement (1 page);
- 3. Form PTO 1449 (4 pages);
- 4. Copies of cited references (C144 C164); and
- 5. Return receipt postcard



Application	Serial Number		10/802,185						
Filing Date			March 17, 2004						
First Named	Inventor		Cheng						
Group Art U	Jnit		2813						
Examiner N	ame		Craig Thompson						
Attorney Do	ocket No.		ASC-025DV1C1						
OSURES (c	heck all that apply)								
Copy of Notice to File Missing Parts of Application				Notice of Appeal to Board of Patent Appeals and Interferences					
Formal Drawing(s)				Appeal Brief (in triplicate)					
Request For Continued Examination (RCE)				Status Inquiry					
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Executed Declaration and Power of Attorney for Utility or Design Patent Application				Additional Enclosure(s) (please identify below)					
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	Date: April 6, 200)5		Natasha C. Us					
00		.15	206	Attorney for Applicant(s)					
2 1221 Tel. No.: (617) 370				Goodwin Procter LLP					
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CORRESPONDENCE ADDRESS Direct all correspondence to: Patent Administr Goodwin Procter Exchange Place Boston, MA 021 Tel. No.: (617) 5'

Fax No.: (617) 52 Customer No. 051414 **Exchange Place** Boston, MA 02109

including Drawings [Total Sheets ____]

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Petition for Extension of

Supplemental Information

Form PTO-1449

Citations (C144 -

Copies of IDS

Disclosure Statement

C164)

☐ Paper Copy/CD

Document(s)

Certified Copy of Priority

Sequence Listing submission

☐ Computer Readable Copy ☐ Statement verifying identity of above

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Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

The references listed on the enclosed PTO-1449 and enclosed herewith are submitted solely in compliance with the duty of candor. It is understood that this Information Disclosure Statement does not fall within the provisions of 37 C.F.R. §1.97.

It is respectfully requested that the publications listed on the attached Form PTO-1449, and other information contained herein, be made of record in this application. In accordance with the U.S. Patent Office's partial waiver of the requirement under 37 C.F.R. 1.98(a)(2)(i), only copies of the non-patent publications are enclosed.

Respectfully submitted,

Date: April <u>&</u>, 2005

Reg. No. 44,381

Natasha C. Us

Attorney for Applicant(s)

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Boston, Massachusetts 02109

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FORM PTO – 1449

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMEN O 1 P

APR 1 3 2005

ATTORNEY DOCKET NO.: ASC-025DV1C1

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EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	. "	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
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	C144	Gannavaram, et al. Source/Drain Tech Digest, (2000), pp.	nology for su									
	C145	Ge et al., "Process- International Elect							ngineering	"" <u>IEEI</u>	3	
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FORM I	PTO –	1449			ATTORN	EY DOCI	KET NO.:	ASC-025	DV10	:1					
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	C160	Shimizu et al., "Lo Enhancement," <u>IE</u>					_						
	C161	Thompson <i>et al.</i> , "25, No. 4 (April 20	_		Featuring Str	ained-Silic	on," <u>IEEE</u>	Electron D	evice L	etters, Vol.			
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	C163	Tiwari et al., "Hole Strain," <u>IEEE Inter</u>								sing Local			
	C164	Uchino, et al., "A CMOS ULSIs," <u>IE</u>											
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